Comparison table of TMP86C829B/H29B/M29B/PM29A/PM29B/C929AXB and TMP86FM29

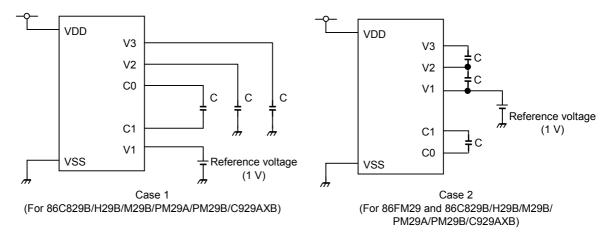
	TMP86C829B TMP86CH29B TMP86CM29B	TMP86PM29A TMP86PM29B	TMP86C929AXB (Emulation chip) (Note 3)	TMP86FM29F
ROM	8 K (Mask ROM) 16 K (Mask ROM) 32 K (Mask ROM)	32 K (OTP)	-	32 K (Flash)
RAM	512 1.5 K 1.5 K	1.5 K	-	2 K
I/O	42	pin	42 pin (MCU part)	42 pin
External Interrupt		5 pin		5 pin
AD Converter		10-bit AD converter × 8	ch	10-bit AD converter × 8 ch
Timer Counter		18-bit timer \times 1 ch 8-bit timer \times 4 ch		18-bit timer × 1 ch 8-bit timer × 4 ch
Serial Interface		8-bit UART / SIO × 1 o	ch	8-bit UART / SIO × 1 ch
LCD		32 seg × 4 com		32 seg × 4 com (Note 2)
Key-on Wakeup		4 ch		4 ch
Operating	1.8 to 5.5 V	at 4.2 MHz	1.8 to 5.25 V at 4.2 MHz	1.8 to 3.6 V at 4.2 MHz (External clock)
Voltage		√ at 8 MHz	2.7 to 5.25 V at 8 MHz	1.8 to 3.6 V at 8 MHz (Resonator)
in MCU Mode	4.5 to 5.5 \	at 16 MHz	4.5 to 5.25 V at 16 MHz	2.7 to 3.6 V at 16 MHz
Operating Temperature in MCU Mode	−40 to 85°C		0 to 60°C	−40 to 85°C
Writing to Flash Memory		-		2.7 to 3.6V at 16 MHz 25°C ± 5°C
CPU Wait (Note 1)		N/A		Available

Note 1: The CPU wait is a CPU halt function for stabilizing of power supply of Flash memory. The CPU wait period is as follows. In the CPU wait period except RESET, CPU is halted but peripheral functions are not halted. Therefore, if the interrupt occurs during the CPU wait period, the interrupt latch is set. In this case, if the IMF has been set to "1", the interrupt service routine is executed after CPU wait period. For details refer to 2.14 "Flash Memory" in TMP86FM29 data sheet.

Thus, even if the same software is executed in 86FM29 and 86C829B/H29B/M29B/PM29A/PM29B /C929AXB, the operation process is not the same. Therefore, when the final operating confirmation on target application is executed for software development of Mask ROM Product (86C829B/H29B/M29B), not the Flash product (86FM29) but the OTP product (86PM29A/PM29B) should be used.

Condition	Wait Time	Halt/Operate			
Condition	vvait riirie	CPU	Peripherals		
After reset release	2 ¹⁰ /fc[s]	Halt	Halt		
Changing from STOP mode to NORMAL mode (at EEPCR <mnpwdw> = "1")</mnpwdw>	2 ¹⁰ /fc[s]	Halt	Operate		
Changing from STOP mode to SLOW mode (at EEPCR <mnpwdw> = "1")</mnpwdw>	2 ³ /fs[s]	Halt	Operate		
Changing from IDLE0/1/2 mode to NORMAL mode (at EEPCR <atpwdw> = "0")</atpwdw>	2 ¹⁰ /fc[s]	Halt	Operate		
Changing from SLEEP0/1/2 mode to SLOW mode (at EEPCR <atpwdw> = "0")</atpwdw>	2 ³ /fs[s]	Halt	Operate		

Note 2: The 86FM29 can not drive the 5V LCD panel because the electrical characteristics in 86FM29 is altered from 86C829B/H29B/M29B/PM29A/PM29B/C929AXB. The recommended operating condition of V3 pin in TMP86FM29 is 3.6V(max). For details, refer to "Electrical Characteristics". When the LCD booster circuit is used in 86FM29, connect the reference voltage and capacitor as shown in "case2". Though the method of "case1" has been recommended in 86C829B /H29B/M29B/PM29A/PM29B datasheets, the 86FM29 should not use method of "case1". Even if the method of "case1" is used in the 86C829B/H29B/M29B/PM29A/PM29B/C929AXB, the function and operation are not issue at all. However, if the "case2" is used, the booster ability becomes higher than "case1". Therefore, when the application board is designed newly in future, the method of "case2" is also recommended in 86C829B/H29B/M29B/PM29A/PM29B/C929AXB.



Note 3: Flash function, CPU wait period and serial PROM mode cannot be emulated in the 86C929AXB. If the software including the flash function is executed in 86C929AXB, the operation process differs from 86FM29.

CMOS 8-Bit Microcontroller

TMP86FM29UG/FG

The TMP86FM29 is the high-speed, high-performance and low power consumption 8-bit microcomputer, including FLASH, RAM, LCD driver, multi-function timer/counter, serial interface (UART/SIO), a 10-bit AD converter and two clock generators on chip.

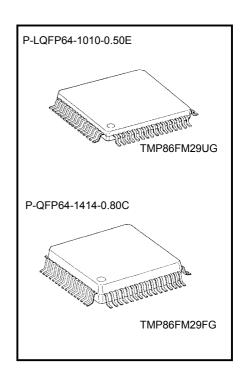
Product No.	FLASH	RAM	Package	Emulation Chip
TMP86FM29UG	22769 9 bita	1526 9 hito	P-LQFP64-1010-0.50E	TMD06C000AVD
TMP86FM29FG	32768 × 8 bits	1536 × 8 bits	P-QFP64-1414-0.80C	TMP86C929AXB

Feautures

• 8-bit single chip microcomputer TLCS-870/C series

Instruction execution time: 0.25 μs (at 16 MHz)
 122 μs (at 32.768 kHz)

- ♦ 132 types and 731 basic instructions
- ♦ 19 interrupt sources (External: 5, Internal: 14)
- ◆ Input/Output ports (39 pins)
 (Out of which 24 pins are also used as SEG pins)
- ♦ 18-bit timer counter: 1 ch
 - Timer, Event counter,
 Pulse width measurement,
 Frequencymeasurement modes
- ♦ 8-bit timer counter: 4 ch
 - Timer, Event counter,
 PWM output, Programmable divider output,
 PPG output modes
- ♦ Time Base Timer
- ♦ Divider output function



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 For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance/Handling Precautions.

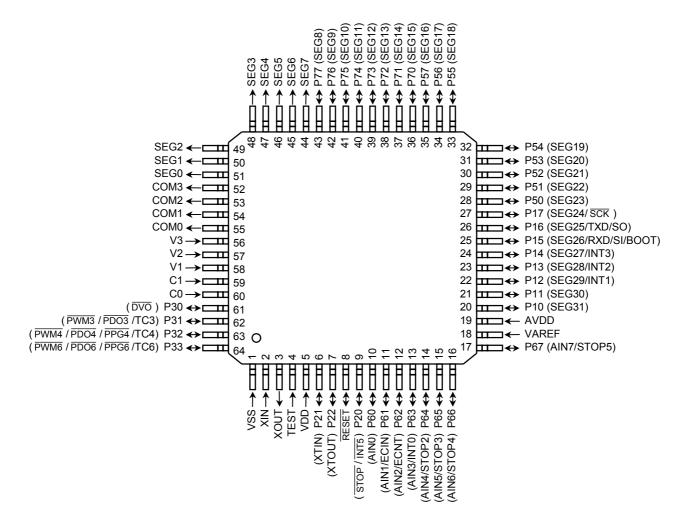
86FM29-1 2004-03-01

- ♦ Watchdog Timer
 - Interrupt source/reset output (programmable)
- ♦ Serial interface
 - 8-bit UART/SIO: 1ch
- ♦ 10-bit successive approximation type AD converter
 - Analog input: 8 ch
- ♦ Four Key-On Wake-Up pins
- ♦ LCD driver/controller
 - Built-in voltage booster for LCD driver
 - With displaymemory
 - LCD direct drive capability (max 32 seg × 4 com)
 - 1/4, 1/3, 1/2duties or static drive are programmably selectable
- Dual clock operation
 - Single/Dual-clock mode
- Nine power saving operating modes
 - STOP mode : Oscillation stops. Battery/Capacitor back-up.
 - Port output hold/High-impedance.
 - SLOW 1, 2 mode: Low power consumption operation using low-frequency clock (32.768 kHz)
 - IDLE 0 mode : CPU stops, and peripherals operate using high-frequency clock of
 - Time-Base-Timer. Release by falling edge of TBTCR <TBTCK> setting.
 - IDLE 1 mode : CPU stops, and peripherals operate using high-frequency clock.
 - Release by interruputs.
 - IDLE 2 mode : CPU stops, and peripherals operate using high and low frequency clock.
 - Release by interruputs.
 - SLEEP 0 mode : CPU stops, and peripherals operate using low-frequency clock of
 - Time-Base-Timer. Release by falling edge of TBTCR <TBTCK> setting.
 - SLEEP 1 mode : CPU stops, and peripherals operate using low-frequency clock.
 - Release by interrupts.
 - SLEEP 2 mode : CPU stops, and peripherals operate using high and low frequency clock.
 - Release by interrupts.
- ♦ Wide operating voltage: 1.8 to 3.6 V at 8 MHz/32.768 kHz
 - 2.7 to 3.6 V at 16 MHz/32.768 kHz

86FM29-2 2004-03-01

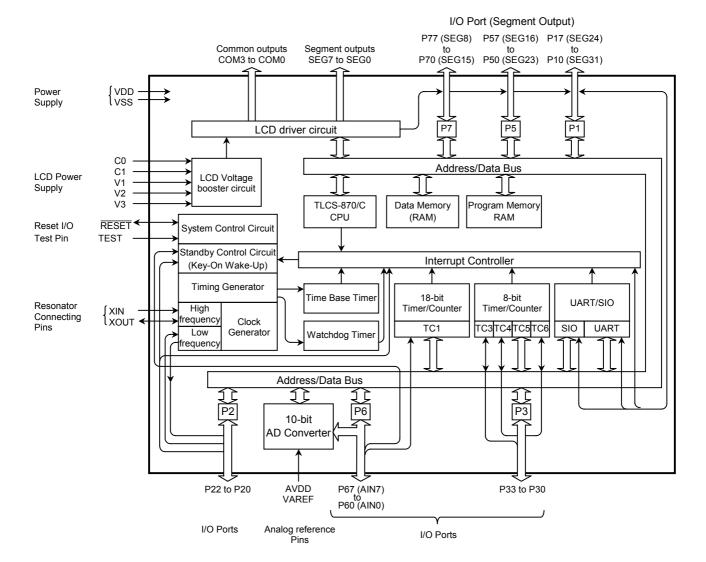
Pin Assignments (Top View)

P-LQFP64-1010-0.50E P-QFP64-1414-0.80C



86FM29-3 2004-03-01

Block Diagram



Pin Functions

Pin Name	Input/Output	Fu	ınctions		
P17 (SEG24, SCK)	I/O (I/O)		Serial clock input/output		
D40 (05005 T D 00)			UART data output		
P16 (SEG25, TxD, SO)	I/O (Output)	8-bit input/output port with latch.	Serial data output		
P15 (SEG26, RxD, SI BOOT)	I/O (I/O)	When used as input port, an external interrupt input, serial interface input/output and UART data input/output, the P1LCR must be set to	UART data input Serial data input Serial PROM mode control input	LCD segment outputs.	
P14 (SEG27, INT3)	I/O (I/O)	"0" after setting output latch to "1".	External interrupt 3 input		
P13 (SEG28, INT2)	I/O (I/O)	When used as a LCD segment output,	External interrupt 2 input		
P12 (SEG29, INT1)	I/O (I/O)	the P1LCR must be set to "1".	External interrupt 1 input		
P11 (SEG30)	I/O (Output)				
P10 (SEG31)	I/O (Output)				
P22 (XTOUT)	I/O (Output)	3-bit input/output port with latch. When	Resonator connecting pins For inputting external clock,		
P21 (XTIN)	I/O (Input)	used as an input port, the output latch	XOUT is opened.	ATIN 15 used and	
P20 (INT5, STOP)	I/O (Input)	must be set to "1".	External interrupt input 5 or release signal input	STOP mode	
P33 (PWM6 , PDO6 PPG6 , TC6)	I/O (I/O)	4-bit programmable input/output port (Nch high current output).	Timer counter 6 input/outpu	t	
P32 (PWM4 , PDO4 PPG4 , TC4)	I/O (I/O)	When used as a timer/counter output or divider output, the output latch must be	Timer counter 4 input/outpu	t	
P31 (PWM3 , PDO3 , TC3)	I/O (I/O)	set to "1". When used as an input port or timer/counter input, the P3OUTCR	Timer counter 3 input/output		
P30 (DVO)	I/O (Output)	must be set to "0" after P3DR is set to "1".	Divider output		
P57 (SEG16) to P50 (SEG23)	I/O (Output)	8-bit input/output port with latch. When used as a LCD segment output, the P5LCR must be set to "1".	LCD segment outputs		
P67 (AIN7, STOP5)	I/O (Input)	8-bit programmable input/output port	STOP 5 input		
P66 (AIN6, STOP4)	I/O (Input)	(tri-state). Each bit of this port can be	STOP 4 input		
P65 (AIN5, STOP3)	I/O (Input)	individually configured as an input or an output under software control. When	STOP 3 input		
P64 (AIN4, STOP2)	I/O (Input)	used as an analog input, the P6CR	STOP 2 input	AD comments	
P63 (AIN3, INTO)	I/O (Input)	must be set to "0" after setting output	External interrupt 0 input	AD converter analog inputs	
,		latch to "0". When used as an input	External interrupt o input	analog inputs	
P62 (AIN2, ECNT)	I/O (Input)	port, a key on wake up input, an	Timer/Counter 1 input		
P61 (AIN1, ECIN)	I/O (Input)	external interrupt input and timer/ counter input, the P6CR must be set to			
P60 (AIN0)	I/O (Input)	"0" after setting output latch to "1".			
P77 (SEG8) to P70 (SEG15)	I/O (Output)	8-bit input/output port with latch. When used as a LCD segment output, the P7LCR must be set to "1".	LCD segment outputs		
SEG7 to SEG0	O. 14m. 14	LCD segment outputs			
COM3 to COM0	Output	LCD common outputs			
V3 to V1	LCD voltage	LCD voltage booster pin.			
C1 to C0	booster pin	Capacitors are required between C0 and	C1 pin and V1/V2/V3 pin an	d GND.	
XIN, XOUT	Input Output	Resonator connecting pins for high-frequ For inputting external clock, XIN is used	=		
RESET	I/O	Reset signal input or watchdog timer reset output		utput/system clock	
TEST	Input	Test pin for out-going test, and the serial low level. When the serial PROM mode s		Usually be fixed to	
VDD, VSS		+5 V, 0 (GND)			
VAREF	Power Supply	Analog reference voltage inputs (High)			
AVDD	,	AD circuit power supply			
7100		AD GIRGUIL POWER SUPPLY			

Operational Description

CPU Core Functions

The CPU core consists of a CPU, a system clock controller, and an interrupt controller.

This section provides a description of the CPU core, the program memory, the data memory, the external memory interface, and the reset circuit.

1.1 Memory Address Map

The TMP86FM29 memory consists of 5 blocks: FLASH memory, BOOT ROM, RAM, DBR (Data buffer register) and SFR (Special function register). They are all mapped in 64-Kbyte address space. Figure 1.1.1 shows the TMP86FM29 memory address map. The general-purpose registers are not assigned to the RAM address space.

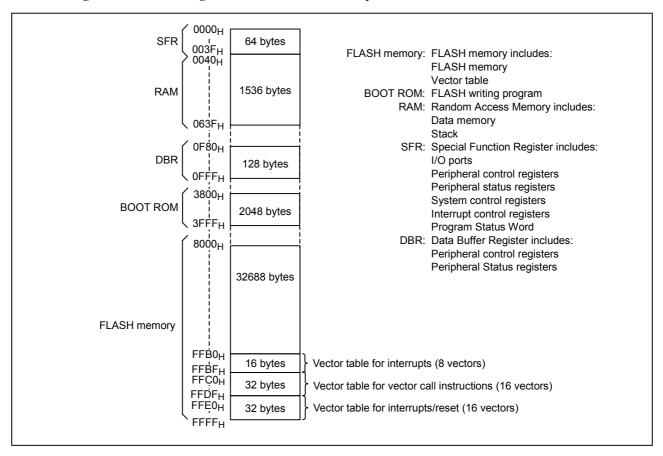


Figure 1.1.1 Memory Address Maps

1.2 Program Memory (FLASH)

The TMP86FM29 has a 32 K × 8 bits (Address 8000H to FFFFH) of Flash memory.

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Electrical Characteristics

Absolute Maximum Ratings (V_{SS} = 0 V)

Parameter	Symbol	Pins	Rating	Unit
Cumply voltage	V_{DD}		-0.3 to 4.0	
Supply voltage	V _{LCD}	V3 pin	-0.3 to 4.0	V
Input voltage	V _{IN}		-0.3 to V _{DD} + 0.3]
Output voltage	V _{OUT1}		-0.3 to V _{DD} + 0.3	
	I _{OUT1}	P3, P6 ports	-1.8	
Output current (Per 1 pin)	I _{OUT2}	P1, P2, P5, P6, P7 ports	3.2	
	I _{OUT3}	P3 ports	30	mA
Output compant (Tatal)	Σl _{OUT2}	P1, P2, P5, P6, P7 ports	60	
Output current (Total)	Σl _{OUT3}	P3 ports	80	
Power dissipation [Topr = 85°C]	PD		350	mW
Soldering temperature (Time)	Tsld		260 (10 s)	
Storage temperature	Tstg		-55 to 125	°C
Operating temperature	Topr	_	-40 to 85	

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Recommended Operating Condition-1 (MCU mode) $(V_{SS} = 0 \text{ V}, \text{Topr} = -40 \text{ to } 85^{\circ}\text{C})$

Parameter	Symbol	Pins	Con	dition	Min	Max	Unit
			fc = 16 MHz	NORMAL1, 2 mode	2.7		
			fc = 8 MHz (In case of connecting	NORMAL1, 2 mode			
Supply voltage V _{DD}	V_{DD}		the resonator) fc = 4.2 MHz (In case of external	NORMAL1, 2 mode	1.8	3.6	
		clock input)	IDLE0, 1, 2 mode SLOW1, 2 mode				
			32.768 kHz	SLEEP0, 1, 2 mode STOP mode	1.8		V
	V _{IH1}	Except Hysteresis input	V _{DD} ≥ 2.7 V	OTOT MODE	V _{DD} × 0.70		
Input high level	V _{IH2} V _{IH3}	Hysteresis input	V _{DD} < 2.7 V		$V_{DD} \times 0.75$ $V_{DD} \times 0.90$	V _{DD}	
Input low level	V _{IL1}	Except Hysteresis input Hysteresis input	$V_{DD} \ge 2.7 \text{ V}$		0	$V_{DD} \times 0.30$ $V_{DD} \times 0.25$	
,	V _{IL3}	·	V_{DD} < 2.7 V			V _{DD} × 0.10	
Clock frequency (In case of connecting	fc	XIN, XOUT	$V_{DD} = 1.8 \text{ to } 3.6^{\circ}$ $V_{DD} = 2.7 \text{ to } 3.6^{\circ}$		1.0	8.0 16.0	MHz
the resonator)	fs	XTIN, XTOUT	$V_{DD} = 1.8 \text{ to } 3.6 ^{\circ}$	V	30.0	34.0	kHz
Clock frequency	fc	XIN, XOUT	$V_{DD} = 1.8 \text{ to } 3.6^{\circ}$ $V_{DD} = 2.7 \text{ to } 3.6^{\circ}$		1.0	4.2 16.0	MHz
clock input)	fs	XTIN, XTOUT	$V_{DD} = 2.7 \text{ to } 3.6^{\circ}$ $V_{DD} = 1.8 \text{ to } 3.6^{\circ}$		30.0	34.0	kHz
LCD reference voltage	V1		Booster circuit is (V3 ≥ V _{DD})	enable	0.8	1.2	V
Capacity for LCD booster circuit	C _{LCD}		LCD booster circ (V3 ≥ V _{DD})	uit is enable	0.1	0.47	μF

Note: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (Supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Recommended Operating Condition-2 (Serial PROM mode) $(V_{SS} = 0 \text{ V}, \text{Topr} = 25^{\circ}\text{C} \pm 5^{\circ}\text{C})$

Parameter	Symbol	Pins	Condition	Min	Max	Unit
Supply voltage	VDD		2 MHz ≤ fc ≤16 MHz	2.7	3.6	٧
Clock frequency	fc	XIN, XOUT	VDD = 2.7 to 3.6 V	2.0	16.0	MHz

Note: The operating temperature area of serial PROM mode is 25° C \pm 5° C and the operating area of high frequency of serial PROM mode is different from MCU mode.

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DC Characteristics $(V_{SS} = 0 \text{ V}, \text{Topr} = -40 \text{ to } 85^{\circ}\text{C})$

Parameter	Symbol		Pir	าร	Cond	lition	Min	Тур.	Max	Unit
Hysteresis voltage	V _{HS}	Hyste	eresis inp	out	V _{DD} = 3.3 V		-	0.4	=	V
	I _{IN1}	TES1	Ī		$V_{DD} = 3.6 \text{ V}, V_{IN} = 0 \text{ V}$		-	_	-5	
Input current	I _{IN2}	Sink	open dra	ain, Tri-state	V _{DD} = 3.6 V, V _{IN}	= 3.6 V/0 V	=	-	±5	μΑ
	I _{IN3}	RESE	T		V _{DD} = 3.6 V, V _{IN}	= 3.6 V	_	-	+5	
land described	R _{IN1}	TES1	pull dov	wn	$V_{DD} = 3.6 \text{ V}, V_{IN}$	= 3.6 V	-	70	-	1.0
Input resistance	R _{IN2}	RESE	T pull u	ıp	$V_{DD} = 3.6 \text{ V}, V_{IN}$	= 0 V	100	220	450	kΩ
High frequency feedback resistor	R _{FB}	XOU ⁻	Г		V _{DD} = 3.6 V		-	3	I	ΜΩ
Low frequency feedback resistor	R _{FBT}	XTOL	JT		V _{DD} = 3.6 V		-	20	I	IVIS 2
Output leakage current	I _{LO}	Sink	Sink open drain, Tri-state		$V_{DD} = 3.6 V$ $V_{OUT} = 3.4 V/0.2$				±10	μА
Output high voltage	V _{OH}	СМО	CMOS, Tri-state		$V_{DD} = 3.6 \text{ V}, I_{OH} = -0.6 \text{ mA}$		3.2	_	ı	V
Output low voltage	V _{OL}	Exce	pt XOUT	, P3 port	$V_{DD} = 3.6 \text{ V}, I_{OL} = 0.9 \text{ mA}$		-	-	0.4	V
Output low current	l _{OL}	P3 pc	ort		$V_{DD} = 3.6 \text{ V}, V_{OL} = 1.0 \text{ V}$		-	6	_	mA
LCD output voltage		V2 pi	n		V3 ≥ V _{DD} Reference supply pin: V1 SEG/COM pin: No load		_	V1 x 2	-	
(LCD booster is enable)	V _{2-3OUT}	V3 pi	n				-	V1 x 3	_	V
Supply current in			Fetch	Flash area	$V_{DD} = 3.6 \text{ V}$	MNP = "1"	-	5.3	7.3	
NORMAL 1, 2 mode			area	RAM area	$V_{IN} = 3.4 \text{ V}/0.2 \text{ V}$	MNP = "0"	_	3.4	5.2	mA
Supply current in					fc = 16 MHz	MNP•ATP = "1"	=	3.1	5.2	IIIA
IDLE 0, 1, 2 mode				T	fs = 32.768 kHz	MNP•ATP = "0"	-	2.2	4.2	
Supply current in			Fetch	Flash area	-	MNP = "1"	-	850	1200	
SLOW 1 mode			area	RAM area	V _{DD} = 3.0 V	MNP = "0"	=	7	19	
Supply current in					$V_{IN} = 2.8 \text{ V}/0.2 \text{ V}$	MNP•ATP = "1"	_	850	1200	
SLEEP 1 mode	-				fs = 32.768 kHz	MNP•ATP = "0"		5.5	17	μА
Supply current in						MNP•ATP = "1"	_	850	1200	F
SLEEP 0 mode						MNP•ATP = "0"		4.5	15	
Supply current in STOP mode					$V_{DD} = 3.6 \text{ V}$ $V_{IN} = 3.4 \text{ V}/0.2 \text{ V}$		-	0.5	10	

- Note 1: Typical values show those at Topr = 25° C.
- Note 2: Input current (I_{IN1} , I_{IN2}): The current through pull-up or pull-down resistor is not included.
- Note 3: I_{DD} does not include I_{REF} current.
- Note 4: The supply currents of SLOW2 and SLEEP2 modes are equivalent to IDLE0, IDLE1, IDLE2.
- Note 5: MNP (MNPWDW) shows bit0 in EEPCR register and ATP (ATPWDW) shows bit1 in EEPCR register.
- Note 6: "Fetch" means reading operation of FLASH data as an instruction by CPU.

AD Conversion Characteristics

(V_{SS} = 0.0 V, 2.7 V \leq V_{DD} \leq 3.6 V, Topr = -40 to 85°C)

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Analog reference voltage	V _{AREF}		A _{VDD} – 1.0	_	A _{VDD}	
Power supply voltage of analog control circuit	A _{VDD}			V_{DD}		V
Analog reference voltage range (Note 4)	ΔV_{AREF}		2.5	-	-	V
Analog input voltage	V_{AIN}		V _{SS}	-	V _{AREF}	
Power supply current of analog reference voltage	I _{REF}	$V_{DD} = A_{VDD} = V_{AREF} = 3.6 \text{ V}$ $V_{SS} = 0.0 \text{ V}$	-	0.35	0.61	mA
Non linearity error		V _{DD} = A _{VDD} = 2.7 V	_	-	±2	
Zero point error			-	-	±2	LSB
Full scale error		$V_{SS} = 0.0 \text{ V}$	_	=	±2	LOB
Total error		V _{AREF} = 2.7 V	_	_	±2	

$$(V_{SS} = 0.0 \text{ V}, 2.0 \text{ V} \le V_{DD} < 2.7 \text{ V}, \text{Topr} = -40 \text{ to } 85^{\circ}\text{C})$$

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Analog reference voltage	V _{AREF}		A _{VDD} – 0.6	-	A _{VDD}	
Power supply voltage of analog control circuit	A _{VDD}			V_{DD}		V
Analog reference voltage range (Note 4)	ΔV_{AREF}		2.0	I	-	V
Analog input voltage	V _{AIN}		V _{SS}	-	V _{AREF}	
Power supply current of analog reference voltage	I _{REF}	$V_{DD} = A_{VDD} = V_{AREF} = 2.0V$ $V_{SS} = 0.0 V$	-	0.20	0.34	mA
Non linearity error		V _{DD} = A _{VDD} = 2.0 V	_	1	±4	
Zero point error		35 155	_	I	±4	LSB
Full scale error		$V_{SS} = 0.0 \text{ V}$	_	ı	±4	LOD
Total error		$V_{AREF} = 2.0 V$	_	_	±4	

$(V_{SS} = 0.0 \text{ V}, 1.8 \text{ V} \le V_{DD} < 2.0 \text{ V}, \text{ Topr} = -10 \text{ to } 85^{\circ}\text{C}) \text{ (Note 5)}$

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Analog reference voltage	V _{AREF}		A _{VDD} – 0.1	-	A _{VDD}	
Power supply voltage of analog control circuit	A _{VDD}			V_{DD}		V
Analog reference voltage range (Note 4)	ΔV_{AREF}		1.8	-	-	V
Analog input voltage	V _{AIN}		V _{SS}	_	V _{AREF}	
Power supply current of analog reference voltage	I _{REF}	$V_{DD} = A_{VDD} = V_{AREF} = 1.8 V$ $V_{SS} = 0.0 V$	-	0.18	0.31	mA
Non linearity error		V _{DD} = A _{VDD} = 1.8 V	_	_	±4	
Zero point error		55 155	-	-	±4	LSB
Full scale error		$V_{SS} = 0.0 \text{ V}$	_	_	±4	LOD
Total error		V _{AREF} = 1.8 V	_	-	±4	

- Note 1: The total error includes all errors except a quantization error, and is defined as a maximum deviation from the ideal conversion line.
- Note 2: Conversion time is different in recommended value by power supply voltage.

 About conversion time, please refer to "2.15.2 Register configration".
- Note 3: Please use input voltage to AIN input Pin in limit of VAREF VSS.

 When voltage of range outside is input, conversion value becomes unsettled and gives affect to other channel conversion value.
- Note 4: Analog Reference Voltage Range: $\Delta VAREF = VAREF VSS$
- Note 5: When AD is used with VDD < 2.0 V, the guaranteed temperature range varies with the operating voltage.
- Note 6: When AD converter is not used, fix the AVDD pin and VAREFpin on the V_{DD} level.

AC Characteristics

 $(V_{SS} = 0 \text{ V}, V_{DD} = 2.7 \text{ to } 3.6 \text{ V}, Topr = -40 \text{ to } 85^{\circ}\text{C})$

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Machine cycle time	40	NORMAL1, 2 mode IDLE1, 2 mode	0.25	-	4	
	tcy	SLOW1, 2 mode SLEEP1, 2 mode	117.6	-	133.3	μs 3
High Level clock pulse width Low level clock pulse width	twcH twcL	For external clock operation (XIN input), fc = 16 MHz	-	31.25	-	ns
High level clock pulse width Low level clock pulse width	twcH twcL	For external clock operation (XTIN input), fs = 32.768 kHz	=	15.26	-	μS

$$(V_{SS} = 0 \text{ V}, V_{DD} = 1.8 \text{ to } 3.6 \text{ V}, \text{Topr} = -40 \text{ to } 85^{\circ}\text{C})$$

Parameter	Symbol	Condition	Min	Тур.	Max	Unit	
Machine cycle time	tcy	NORMAL1, 2 mode IDLE1, 2 mode	0.5	-	4		
		SLOW1, 2 mode SLEEP1, 2 mode	117.6	-	133.3	μ\$	
High level clock pulse width Low level clock pulse width	twcH twcL	For external clock operation (XIN input), fc = 4.2 MHz	-	119.04	-	ns	
High level clock pulse width Low level clock pulse width	twcH twcL	For external clock operation (XTIN input), fs = 32.768 kHz	=	15.26	-	μS	

Timer Counter 1 input (ECIN) Characteristics (V_{SS} = 0 V, Topr = -40 to 85°C)

Parameter	Symbol	Condition		Min	Тур.	Max	Unit
TC1 input (ECIN input)	t _{TC1}	Frequency measurement mode V _{DD} = 2.7 to 3.6 V	Single edge count Both edge count	_	-	16	
		Frequency measurement	Single edge count	_	_	8	MHz
		mode V _{DD} = 1.8 to 2.7 V	Both edge count				

Flash Characteristics (V_{SS} = 0 V)

Parameter	Condition	Min	Тур.	Max	Unit
Number of guaranteed writes (page writing) to Flash memory in serial PROM mode	$V_{DD}=2.7$ to 3.6 V, 2 MHz \leq fc \leq 16 MHz (Topr = 25° C \pm 5° C)	-	_	10 ⁵	Times

Recommended Oscillating Conditions

- Note 1: An electrical shield by metal shield plate on the surface of IC package is recommended in order to protect the device from the high electric field stress applied from CRT (Cathodic Ray Tube) for continuous reliable operation.
- Note 2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following http://www.murata.co.jp/search/index.html